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Electron transfer induced thermochromism in a VO$_2$–graphene–Ge heterostructure

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Abstract

As a marvelous thermochromic material, vanadium dioxide (VO₂) holds great promise for applications in smart devices due to semiconductor-metal transition (SMT), an active response to external temperature stimuli and near-infrared irradiation. Here, we demonstrate for the first time that the phase transition temperature of VO₂ film can be effectively manipulated by using graphene as interlayer. High quality graphene monolayer was chemical vapor deposited on Ge underlayer, followed by growing VO₂ film onto graphene to form semimetal-semiconductor contact, namely, a VO₂-graphene-Ge junction. The thermochromic properties of VO₂ film were demonstrated with ~20% infrared reflectance contrast. Furthermore, the transition temperature of VO₂ film was effectively reduced to from 340 K to 330 K. On the basis of the Mott-Hubbard phase transition theory, a plausible mechanism is proposed here for the first time from the perspective of charge transfer to elucidate the experimental phenomenon, which believes that the electron transfer can increase the electron concentration in VO₂ film, destabilize the semiconductor phase of VO₂ film and thus decrease the SMT temperature of thermochromic VO₂ film. In addition to stimulating scientific interest, this study may also contribute to thermochromic VO₂-based applications in sensors, optical and electrical switches, and other nanodevices.

Keywords: Vanadium Dioxide, Thermochromic, Semiconductor-Metal Transition, Graphene, Germanium
1. Introduction

Vanadium dioxide (VO$_2$) is one of the most attractive thermochromic materials, which undergoes a reversible semiconductor-metal transition (SMT) from a high temperature rutile phase (P4$_2$/mmn, R) to a low temperature monoclinic phase (P2$_1$/c, M1) at critical temperature of $T_c \sim 340$ K.$^{1, 2}$ Concomitant with the phase transition is discontinuous jumps in electrical conductivity, optical transmittance, magnetic susceptibility, specific heat, and the Seebeck coefficient.$^{3, 4}$ Great efforts have been devoted to the VO$_2$ thin films due to their extensive applications as well as the enigmatic microscopic mechanism of the phase transition. The Peierls mechanism, which believes the driving force of the SMT in VO$_2$ is the electron-phonon interaction and the Mott-Hubbard transition which supports the electron-electron interaction are believed to be the two major mechanisms. However, both mechanisms are still under intense debate and many efforts have been made to clarify them.

The microstructure and properties of VO$_2$ films exhibited strong dependence upon the substrates as well as the buffer layers. The supporting materials such as glass,$^5$ silicon,$^6$ sapphire$^7$ and titanium dioxide$^8$ are the most frequently used as the substrates for VO$_2$ films. By varying the substrates, the crystallization behavior (amorphous, polycrystalline or epitaxial film), transition temperature and hysteresis width of the VO$_2$ films can be regulated. The buffer layer (the interlayer between the substrate and the VO$_2$ film) also plays a significant role in the behaviors of VO$_2$ films. Up to present, the buffer layers of SiO$_2$$^{9, 10}$, ZnO,$^{11}$ SiN$_x$$^{12}$, RuO$_2$$^{13}$, TiO$_2$$^{14}$ and metals (V, W, Fe, Ni, etc.)$^{15}$ have been widely investigated. Graphene, recognized as a
zero-gap semiconductor (namely, semimetal), is a two-dimensional (2D) hexagonal honeycomb structure and possesses excellent carries mobility (~ 200 000 cm² V⁻¹ S⁻¹) and thermal conductivity (~ 5.0 × 10³ W m⁻¹ K⁻¹). Based on its unique properties, one can expect that graphene has the potential to act as a functional buffer layer. However, it is still a mystery how the graphene layer will influence the microstructure and properties of VO₂ films, which needs to be investigated and elucidated.

To date, large-area graphene has been produced on various metal substrates and it is necessary for intended use to transfer the as-grown graphene onto desired substrates. However, these wet-transfer processes may be only feasible for the graphene with small lateral sizes. Also, some additional mechanical stress on graphene is anticipated during the transfer process. To overcome the drawback of undesirable impurities and wrinkle formation during the transfer process, direct synthesis of graphene on required substrate has been explored for practically feasible device applications. As a consequence, it is a scientific action to investigate the microstructure and properties of VO₂ films based on the buffer layer of the graphene without transfer process. Group (IV) semiconductors, including Si and Ge, play a critical role in modern technology, which are widely used in integrated circuits (ICs), chemical sensors, infrared (IR) detectors, and micro-/nanoelectromechanical systems (MEMS/NEMS), etc. And recently, large-area graphene film was demonstrated to grow directly on Ge layer.

In this work, we attempt to deposit VO₂ thin film on transfer-free Graphene/Ge substrate and investigate the switching behaviors of VO₂ layer. The results show that monolayer graphene
can reduce the transition temperature of VO$_2$ film by ~ 10 K. On the basis of the band theory, we conjecture that this phenomenon is ascribed to the electron injection from graphene to VO$_2$ film, which leads to a rise of the electron concentration in VO$_2$. To the best of our knowledge, this work has not been investigated before.

2. Materials and methods

2.1. Fabrication of graphene films

The graphene was prepared by atmospheric pressure chemical vapor deposition (APCVD) technique on 175-µm-thick Ge substrate. Prior to being placed at the center of horizontal quartz tube, the Ge substrates were cut into 2 cm × 2 cm pieces and ultrasonically cleared in the alcohol (Adamas-beta Inc., Shanghai, China) for 10 min. The synthesis was carried out by using a horizontal tube furnace with a quartz processing tube inside (inner diameter of 50 mm). The quartz tube was evacuated to about $10^{-5}$ mbar and then filled with 200 sccm (sccm denotes standard cubic centimeter per minute at STP) Ar gas (purity, 99.999%) and 50 sccm H$_2$ gas (purity, 99.999%). After heating to 910 °C, CH$_4$ gas (purity, 99.999%) was introduced to grow the graphene for 100 min. Finally, the furnace was cooled to room temperature under the flowing mixture of H$_2$ and Ar.

2.2. Preparation of VO$_2$ films
The VO$_2$ films were fabricated through reactive sputtering of 3-inch metal vanadium target with oxygen content of 15 sccm at radio frequency power of 200 W. Before VO$_2$ films growth process, the deposition chamber was pumped down to ~10$^{-4}$ Pa and pure Ar gas (purity, 99.999\%) was introduced at 25 sccm. During the deposition process, the substrates were kept at 450 $^\circ$C for the fine crystallinity of VO$_2$ thin films and rotated along the vertical axis at a speed of 10 rpm to improve the film homogeneity. After the VO$_2$ films were deposited, samples were cooled down spontaneously to ambient temperature. The thickness of VO$_2$ layer was approximately 50 nm.

2.3. Characterization of samples

The graphene layer and VO$_2$ film were characterized with Raman spectroscopy (Renishaw inVia, UK) under the excitation wavelength of 514 nm with a low output power of 10 mW. Scanning tunnel microscopy (STM; MultiMode 8, BRUKER, USA) was used to obtain the atomic-scale pattern of graphene. The surface morphology was examined by field-emission scanning electron microscopy (FE-SEM; Magellan 400, FEI, USA). The atomic force microscopy (AFM) image was collected using a Nanocute SII scanning probe microscopy operated in tapping mode under ambient conditions. Etched Si nanoprobe tips with spring constant of 40 N/m and resonance frequency of 300 KHz $\pm$ 100 KHz were adopted. The surface chemical compositions and chemical states were determined by X-ray photoelectron spectroscopy (XPS; PHI 5802, Physical Electronics Inc, Eden Prairie, MN). The microstructure and composition of samples were further analyzed on a field-emission transmission electron
microscope (TEM; JEM-2100F, JEOL Ltd, Tokyo, Japan) with an accelerating voltage of 200 kV. Graphene film was transferred from Ge substrate onto TEM grids by PMMA-assisted wet-transfer method. Briefly, after etching away the substrate by the mixture of HNO₃ and HF (Adamas-beta Inc., Shanghai, China), the PMMA/graphene layer was transferred to TEM grids, followed by annealing at 50°C for 1.5 h to improve adhesion. The PMMA was then dissolved gradually with acetone (Adamas-beta Inc., Shanghai, China). Finally, the graphene was washed with isopropanol (Adamas-beta Inc., Shanghai, China) for further characterization. The diffuse reflection spectra were recorded by the spectrophotometer (Hitachi Corp., Model UV-4100) equipped with an attachment to control the temperature of the films. The temperature was measured precisely with a temperature sensor in contact with the surface of films, and it was controlled via a temperature controlling unit. Hysteresis loops were measured by collecting the transmittance spectra of samples at a fixed wavelength with a heating rate of ~ 4 °C /min. Photoluminescence (PL) analysis was conducted using a FluoroMax®-4 fluorescence spectrometer (Horiba Scientific, New Jersey, USA) equipped with a broadband pulsed UV xenon lamp source.

3. Results and discussion

3.1. Graphene characterization
The high quality of graphene is essential to assure its practical applications. Herein, Raman microscopy was adopted to characterize the crystalline quality and defect state of the CVD-derived graphene film, as shown in Figure 1a. It can be seen that the typical features of graphene, namely, the 2D peak at ~ 2710 cm$^{-1}$ and the G peak at ~ 1580 cm$^{-1}$, emerge. The absence of D peak (~ 1350 cm$^{-1}$) indicates that the graphene layer possesses the negligible defect state, in other words, the superior crystalline quality. Cançado et al.$^{19}$ have shown that one can successfully determine the crystallite size, L$_a$ (nm), of nanographite by Raman spectroscopy using the general equation $L_a = (2.4 \times 10^{-10}) \lambda^{-4} (I_D/I_G)^{-1}$, where $\lambda$ is the laser line wavelength in nanometer units, I$_D$ and I$_G$ are the intensity of the D band and G band, respectively. From the above equation, the crystal domain size of graphene is ~ 4086.2 nm. To further estimate the quality and uniformity of the graphene film on Ge substrate, the intensity ratios of 2D band to G band over a randomly selected area of 25 $\mu$m $\times$ 25 $\mu$m were recorded by Raman mapping method with a spot size of 1 $\mu$m and a step size of 1 $\mu$m, as shown in Figure 1b. The I$_{2D}$/I$_G$ ratios are quite uniform over the region in the range of 1~2, which, in other words, demonstrates the high quality and superior uniformity of graphene film on Ge at the corresponding scale. Figure 1c shows the STM topography of the graphene on Ge with the typical hexagonal lattice at the atomic scale, which originates from the intrinsic feature of graphene. Meanwhile, the high-resolution XPS spectra show that, before graphene deposition, the carbon species on Ge stem from surface contamination, indicated by the C1s peak at 285 eV, typical of the $sp^2$-bonded carbon (Figure 1d). In comparison, for Graphene/Ge, the C1s peak in Figure 1e is dominated by
the \( sp^2 \)-bonded carbon at 284.64 eV corresponding to the C1s in graphene.\(^{20}\) Furthermore, the graphene film was transferred onto the copper grids for TEM analysis to acquire the detailed crystallographic information and layer number. It is observed that the suspended graphene film on the TEM grids is continuous over a large area, as shown in Figure 1f. Meanwhile, the inserted SAED (namely, selected area electron diffraction) pattern clearly shows that only one set of hexagonal diffraction pattern exists, demonstrating that the graphene film is single-layer and of high crystalline quality. And, the single-layer characteristic of the graphene film was further been validated by the randomly selected high resolution TEM image of the graphene edge in Figure 1f, showing the thickness of \(~ 0.34\) nm for graphene monolayer.

### 3.2. VO\(_2\)-graphene–Ge characterization

As for the VO\(_2\)-graphene–Ge sample, almost all the known Raman modes of monoclinic VO\(_2\) are present, as shown in Figure 2a. The Raman band positions are in accordance with prior literature,\(^ {21} \) and no other peaks irrelative to VO\(_2\) phase can be observed, which provides a valid evidence that no other phases have been formed. Figure 2b shows the surface topography of the VO\(_2\) film on Graphene/Ge with a thickness of \(~ 50\) nm measured from the cross-sectional view (Figure 2c). From the surface morphology, one can see that structural fluctuation forms on the VO\(_2\) film. In other words, pits and ridges seem on the surface of VO\(_2\) film. To further determine the surface structural feature of VO\(_2\) film, AFM was used to explore the film in tapping mode on a randomly selected region. As shown in Figure 2d, interestingly, apparent structural fluctuation
of pits and ridges can be seen on the VO$_2$ film. This type of structural fluctuation is considered to result from the intrinsic wrinkle formation of graphene film,\textsuperscript{22,23} which will be further discussed in Figure 3. The RMS (Root-Mean-Square) surface roughness for the VO$_2$ film on Graphene/Ge is approximately 5 nm.

To determine the valence state of vanadium (V) in the oxide film, XPS examination was performed on the VO$_2$–graphene–Ge surface. From the high resolution XPS spectrum of V 2p in Figure 3a, the valence state of V was confirmed to be +4, and the XPS spectrum indicates two peaks centered at around 516.3 eV and 523.5 eV which correspond to the typical binding energies for V 2p$_{3/2}$ and V 2p$_{1/2}$ in VO$_2$, respectively. Meanwhile, the source of carbon species can also be found out from the surface XPS analysis of VO$_2$–graphene–Ge. As shown in Figure 3b, the high resolution C 1s XPS spectrum reveals that the carbon species on the VO$_2$ film originate from the surface contamination of $sp^3$-bonded carbon with the C1s peak at 285 eV, which is due to the fact that the thickness of the continuous VO$_2$ film (~ 50 nm) exceeds the sampling depth of XPS analysis (less than 10 nm). As a consequence, the graphene layer under the VO$_2$ film cannot be detected by the XPS. In order to define the microstructure of the VO$_2$–graphene–Ge, we have employed the XRD and HR-TEM characterizations. From the XRD analysis result (not listed here), we found that the VO$_2$ film on Graphene/Ge mainly consisted of an amorphous phase. Figure 3c-d shows the randomly selected cross-sectional TEM image, HR-TEM image and SAED pattern of the VO$_2$–graphene–Ge. From the corresponding HR-TEM image in Figure 3d, the trenchant lattice fringe indicates the excellent crystallinity of the
underlying Ge. On the contrary, the VO\textsubscript{2} film grown on graphene support presents an unorderly lattice fringe although some tiny crystallite grains exist, showing the poor crystallization quality further demonstrated by the corresponding SAED pattern. A plausible mechanism is proposed here, that is, the atomic-scale wrinkles of graphene plays a crucial role in the crystallinity of the deposited film\textsuperscript{24-26} At the same time, the VO\textsubscript{2} film grows tightly along the graphene layer and tightly sticks together with the graphene wrinkles. As a result, their interface tightly bonds together without significant microcracks or micropores.

3.3. Thermochromism in VO\textsubscript{2}–graphene–Ge heterojunction

The thermochromic properties are clearly exhibited in Figure 4a, which shows an obvious reflectance contrast in the near-infrared region. Since the optical properties of Graphene/Ge substrate are insensitive to temperature, the reflectance change is attributed to the thermochromic nature of VO\textsubscript{2} thin film. At the wavelength of 2000 nm, for instance, the reflectance is \( \sim 32.8\% \) in the semiconductor phase while it reaches \( \sim 55.5\% \) in the metal phase. The plasma frequency (\( \omega_p \)) for metallic state VO\textsubscript{2} is reported to be 1.0 eV (\( \sim 1240 \) nm)\textsuperscript{27} or 1.6 eV (\( \sim 775 \) nm)\textsuperscript{28}, thus the rutile phase has a higher reflectance in the IR region since the incident light at a frequency below the plasma frequency leads to motion in the charge carriers that acts to screen out the incident field, in other words, to reflect the incident waves\textsuperscript{29}.

The switching behavior of VO\textsubscript{2} thin film can be more clearly elucidated by means of thermal hysteresis loops. Figure 4b shows the loops of VO\textsubscript{2}-Ge and VO\textsubscript{2}-Grphene-Ge samples.
measured at wavelengths of 650 nm and 2000 nm. For the two samples, the loop measured at 650 nm exhibits a very small contrast in the reflectance spectra compared with that at 2000 nm. In effect, the switching capability is prominent in the spectral range from the wavelength of 1000 nm to 2500 nm, as seen in Figure 4a. One can note that the thermal hysteresis loop in the long wavelength region (\( \lambda > 1000 \) nm) follows the anticlockwise direction. In contrast, the thermochromism of the VO\(_2\) film in the region from 500 nm to 800 nm is quite on the contrary. The hysteresis loop at 1000 nm follows the clockwise direction, as seen in Figure 4b.

According to the hypothesis proposed by Klimov et al.,\(^{30}\) the hysteresis phenomena during the phase transition were regarded as the integrated outcome of the elementary loops of the grains. This means that the reason for the difference in the hysteresis loop parameters between VO\(_2\) films and bulk single crystals is the presence of a large number of grains of various sizes in VO\(_2\) films. When the VO\(_2\) film is heated up, the growth of a metallic nucleus in the semiconductor phase is stable if the temperature differs from the phase equilibrium temperature (\(T_c\)) by a value of \(\Delta T_+\). When the film is cooled down, the stable growth of a semiconducting nucleus in the metallic phase takes place, as before, if there is a temperature difference \(\Delta T_-\). Since the distributions of grain size are so wide and therefore the deviations \(\Delta T_+\) and \(\Delta T_-\) from \(T_c\) for the VO\(_2\) film amount to several tens of degrees (against one or two degrees for the single crystal), the loop for the film is also much wider than that for the single crystal. Moreover, since the transition temperature for a specific grain in the heating process (\(T^* = T_c + \Delta T_+\)) is larger than that in the cooling process (\(T^{**} = T_c - \Delta T_-\)), the integral of transition temperature over all the
grains in the film brings about the result that the heating branch of the loop is always on the right side, when compared to the cooling branch. As a consequence, the hysteresis loop will follow the anticlockwise direction if the reflectance in the low-temperature phase is smaller than that in the high-temperature phase. In the same way, the loop will follow the clockwise direction if the reflectance in the monoclinic phase is larger than that in the rutile phase. As a matter of fact, very few researches about such an anomalous switching behavior, also reported in the VO$_2$/sapphire system in the transmittance spectra,\textsuperscript{31} were carried out in depth. It remains to be further investigated what causes or affects the existence of anomalous behavior and whether the eccentric phenomenon has the value of practical applications or not.

The transition temperature (defined as the central temperature of the hysteresis loop) of the sandwich-structure sample is around 330 K which is lower than that of VO$_2$ films on Ge substrate (337 K), let alone lower than that of bulk VO$_2$ single crystal ($T_c \sim 340$ K \textsuperscript{32}). The $T_c$ value can be reduced in many approaches. First, a slight deviation from stoichiometry\textsuperscript{33}, either under- or over-stoichiometry, is known to reduce $T_c$. However, this factor can be eliminated since the valence state of V has been confirmed by the XPS spectra, as seen in Figure 3a. Second, the transition temperature can be modified by imposing pressure or uniaxial/biaxial stress\textsuperscript{34,35} or doping\textsuperscript{36}. Applying pressure is not an effective method since the volume change at the SMT is much weaker than the $c$-axis expansion.\textsuperscript{37} However, relatively large stress dependence was reported under uniaxial stress along the $c$-axis of VO$_2$ ($dT_c/d\sigma \approx 1.2$K kbar\textsuperscript{-1})\textsuperscript{38} and the rate at which the transition temperature is modified by the uniaxial stress can be
evaluated by the Clausius–Clapeyron equation.\textsuperscript{39} Apparently, pressure or uniaxial stress was not imposed here in this work. Third, the total stress in the film, as a combination of thermal stress (tensile) caused by the difference in thermal expansion coefficients (TEC) between film and substrate and the internal stress (compressive) produced by the ion-bombardment effect during the film growth, causes a reduction in $T_c$ value. Nevertheless, the transition temperature for the VO$_2$ film directly grown on Ge substrate was $\sim 337$ K. The TEC value of graphene is strongly dependent on temperature but remains negative in the temperature range from 300 K to 400 K with a room-temperature value of $\sim -8.0 \times 10^{-6}$ K$^{-1}$.\textsuperscript{40} However, the TEC values are $2.1 \times 10^{-5}$ K$^{-1}$ \textsuperscript{41} and $6.65 \times 10^{-6}$ K$^{-1}$ \textsuperscript{42} for VO$_2$ and Ge, respectively. That is to say, the middle-layer graphene shrinks when it is exposed to the heat, while the upper-layer VO$_2$ thin film and the bottom-layer Ge substrate expand. In Lee’s and his co-workers’ study, they also found the depressed $T_c$ value in graphene-supported VO$_2$ films on the sapphire substrate, and they attributed this phenomenon to the TEC differences.\textsuperscript{43} Although the mismatch of TEC between the film and the substrates cannot be eliminated, the intrinsic particularity of graphene should not be neglected here.

Herein, we try to discuss the potential mechanism of the reduction in $T_c$ by the addition of graphene monolayer. Considering the zero-gap and semimetal features of graphene, when it comes to directly contact with semiconductor Ge, especially to directly grow on semiconductor Ge in situ, it is expected that a Schottky barrier will be formed due to the alignment of Fermi level at the interface between semimetal (graphene) and semiconductor (Ge).\textsuperscript{44} Figure 5a shows
the UV-Vis diffuse reflectance spectra of the Graphene/Ge and Ge substrates. The Kubelka–Munk function is adopted to convert the diffuse reflectance measurement into the equivalent absorption coefficient.\(^{45}\)

\[
\alpha = \frac{(1-R)^2}{2R}
\]

where \(\alpha\) is the optical absorption coefficient near the absorption edge for indirect interband transition, \(R\) is the reflectance of semiconductor, \(R = 10^{-A}\), and \(A\) is the optical absorbance.

\[
a h\nu = C_1 (h\nu - E_g)^2
\]

\[
h\nu = \frac{1240}{\lambda}
\]

where \(C_1\) is the constant for indirect transition, \(h\nu\) is the photon energy, \(E_g\) is the indirect bandgap energy (eV), and \(\lambda\) is the wavelength (nm).

**Figure 5b** indicates the \((a h\nu)^{1/2}\) plotted versus \(h\nu\) and the vertical segment of the spectra is extended to intersect the \(h\nu\) axis to acquire the \(E_g\) value of the measured specimen. The \(E_g\) value of Ge specimen is 0.625 eV while the Graphene/Ge substrate characterizes an \(E_g\) value of 0.592 eV. As apparent from **Figure 5a-b**, the existence of zero-gap graphene in the Graphene/Ge heterostructure contributes to a red shift of the absorption edge, which thus narrows the bandgap of the Ge specimen. The narrowed bandgap demonstrates the Schottky barrier formation and Fermi level alignment at the interface of the Graphene/Ge heterojunction, which thus modifies the electronic structures and influences the optical properties. **Figure 5c** shows the photoluminescence (PL) spectra of the Ge and Graphene/Ge excited by a broadband pulsed UV xenon lamp source. Upon UV irradiation, that is, when Ge is excited by photons with minimal
energy equal to its bandgap, electrons transfer to the conduction band from the valence band. After that, the electrons relax extremely fast and rapidly recombine with holes in the valence band. As a consequence, the narrowed bandgap of Graphene/Ge heterostructure can facilitate charge separation to produce electron/hole (e⁻/h⁺) pairs and thus enhance the PL intensity upon e⁻/h⁺ recombination, as shown in Figure 5c. On the other hand, if the excited electrons can be transferred to another intended target in time, for example, to the VO₂ film, then this attempt may affect the electronic structures and optical properties of the VO₂ film.⁴⁶,⁴⁷

In fact, a semimetal-semiconductor junction will be produced when graphene grows on Ge, accompanied by the Schottky barrier formation and Fermi level alignment at the contact interface.⁴⁸ During this process, an electronic charge flowing usually occurs. To figure out the electron flowing direction, the energy band diagrams of the interconnecting materials should be taken into consideration. Some previous data⁴⁹-⁵³ and the above calculated values are utilized to draw the band structures, as listed in Table 1. The vacuum level (E₀) is used as a reference. The work function Φ of graphene is 4.23 eV, which is greater than that of Ge (Φ' = 4.1 eV), namely, the Fermi level Eᶠ⁻ of Ge higher than that of graphene (Eᶠ⁻). As the couple of materials come into contact, electrons will be driven to flow from conduction band of Ge to graphene until their Fermi levels become aligned. In fact, graphene can act as an excellent electron acceptor owing to its 2D π-conjugation structure,⁵⁴ which can further facilitate the electrons flowing from Ge to graphene. The energy band diagrams before and after contact are depicted in Figure 6a-b. On the other hand, the work function Φ'' of VO₂ is 5.15 eV, which is
greater than that of graphene. Once the couple of materials are brought into contact, electrons will be driven to flow from graphene to VO$_2$ until their Fermi levels alignment at the contact interface. In reality, graphene can also serve as an excellent electron transporter to achieve efficient charge separation due to its 2D planar structure,\textsuperscript{55-58} which can further promote the electrons transferring from graphene to VO$_2$. Moreover, in single-layer graphene, electrons can behave as massless Dirac fermions. \textbf{Figure 6c-d} shows the energy band diagrams before and after contact. Here, the Graphene/Ge support behaves as electron donor and provides electrons for VO$_2$, which thus can increase the electron density in VO$_2$ film and modify the electronic structure of VO$_2$.\textsuperscript{59} That is to say, such an increase of electron density in VO$_2$ film, especially upon light irradiation, will consequentially destabilize the semiconductor phase of thermochromic VO$_2$ film on the basis of the theory of Zylbersztejn and Mott, in which the SMT of VO$_2$ is shown to be of Mott-Hubbard transition and driven by the increase of electron density. In other words, once the electron density reaches a critical value, the SMT can be triggered and a metal phase can be generated.\textsuperscript{1,60} For example, the critical electron density is approximately $10^{18}$ $\sim 10^{19}$ cm$^{-3}$ for the Mott transition of bulk VO$_2$ with $T_c \sim 68$ °C.\textsuperscript{61} Based on these analyses, the SMT of thermochromic VO$_2$ film may be triggered at a relatively lower temperature rather than at the temperature of $\sim 68$ °C, as we observed in this study. It is expected that charge transfer to a thermochromic material manipulated by appropriate materials design can induce its structural phase transition. For example, the excited hot carriers formed by surface plasmon resonance (SPR) may be utilized to inject into a thermochromic material to induce its structural phase
transition. In fact, a recent study has demonstrated that the hot electrons produced by plasmonic Au nanoparticles deposited on MoS$_2$ layer can induce a transient reversible first-order phase transition in which the Mo coordination changes from a direct band gap semiconducting trigonal prismatic (2H) structure to a metallic octahedral (1T) structure. In a word, we propose that the plausible mechanism behind the present structural phase transition is electron injection and doping to destabilize thermochromic VO$_2$ film. We hope this study can provide new insights and pave the way for the development of active optical devices to exploit the fantastic electronic and structural properties of 2D structures and materials.

4. Conclusions

In conclusion, vanadium dioxide (VO$_2$) thin film has been successfully deposited on transfer-free monolayer graphene support by the magnetron sputtering method. The as-prepared VO$_2$ film has been demonstrated to consist of pure phase with ~ 20% infrared reflectance contrast in the IR range. For the VO$_2$-graphene-Ge junction, the presence of graphene interlayer can effectively reduce the SMT temperature of VO$_2$ thin film from ~ 340 K to ~ 330 K. On the basis of the Mott-Hubbard phase transition theory, a plausible mechanism is proposed here for the first time from the perspective of electron transfer to elucidate the reduced transition temperature of VO$_2$ film by ~ 10 K, which believes that the electron transfer can increase the electron density in VO$_2$ film, destabilize the semiconductor phase of VO$_2$ film and thus decrease the SMT temperature of thermochromic VO$_2$ film. This investigation may provide insights for
choosing graphene as a matrix for thermochromic VO$_2$ films and offer potential applications in sensors, optical and electrical switches, and other nanodevices.

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**Notes and references**

Electronic Supplementary Information (ESI) available: [details of any supplementary information available should be included here]. See DOI:


Table 1. Data for the energy level positions of VO$_2$, graphene and Ge.

<table>
<thead>
<tr>
<th>Materials</th>
<th>$\Phi$ (eV)</th>
<th>$E_g$ (eV)</th>
<th>$\chi$ (eV)</th>
<th>$E_c$ (eV)</th>
<th>$E_v$ (eV)</th>
</tr>
</thead>
<tbody>
<tr>
<td>VO$_2$ (M1)</td>
<td>5.15$^{49}$</td>
<td>0.6$^{50, 51}$</td>
<td>4.85$^a$</td>
<td>-4.85$^a$</td>
<td>-5.45$^a$</td>
</tr>
<tr>
<td>Graphene</td>
<td>4.23$^{52}$</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Ge</td>
<td>4.1$^a$</td>
<td>0.625$^a$</td>
<td>4$^{53}$</td>
<td>-4$^a$</td>
<td>-4.625$^a$</td>
</tr>
</tbody>
</table>

Notes: $E_0$, vacuum level; $E_F$, Fermi level; $\Phi$, work function; $E_g$, bandgap; $\chi$, electron affinity; $E_c$, conduction band; $E_v$, valence band; $a$, Calculated values.
Figure 1. (a) Raman spectrum of the graphene directly grown on Ge, inserted with the schematic illustration for Graphene/Ge substrate. (b) Two-dimensional Raman mapping of the $I_{2D}/I_G$ peak intensity ratios obtained from the graphene deposited on Ge (a randomly selected 25 μm × 25 μm region with the spot size of 1 μm and the step size of 1 μm). (c) STM topography image of the graphene layer on Ge. (d-e) XPS analysis results showing the C 1s XPS spectra acquired from the surfaces of Ge (d) and Graphene/Ge (e). (f) TEM image of the transferred graphene film from Ge, inserted with the corresponding SAED pattern. The right inset in (f) shows the corresponding HR-TEM image of monolayer graphene edge with one carbon layer, with a scale bar of 3 nm.
Figure 2. (a) Raman spectrum of the VO$_2$ thin film deposited on Graphene/Ge support, inserted with the schematic illustration for the VO$_2$-graphene-Ge junction. (b) Surface morphology of the VO$_2$ thin film on Graphene/Ge support examined by SEM. (c) Cross-sectional view of the VO$_2$-graphene-Ge junction examined by SEM. (d) Surface topography of the VO$_2$ thin film grown on Graphene/Ge support examined by AFM.
Figure 3. (a) XPS analysis result showing the V 2p XPS spectrum obtained from the surface of VO₂ thin film grown on Graphene/Ge support. (b) XPS analysis result showing the C 1s XPS spectrum acquired from the surface of VO₂ thin film on Graphene/Ge support. (c) Cross-sectional view of the VO₂-graphene-Ge junction examined by TEM, showing the top-layer VO₂, middle-layer graphene and bottom-layer Ge. (d) HR-TEM image of the VO₂-graphene-Ge junction corresponding to the red rectangular area in (c). The inset in (d) shows the SAED pattern corresponding to the red rectangular area in (d).
Figure 4. (a) Reflectance spectra of the Graphene/Ge and the VO$_2$ thin film grown on the Graphene/Ge support. (b) Thermal hysteresis loops of reflectance measured at the wavelengths of 650 nm and 2000 nm for the VO$_2$ thin film on Ge and Graphene/Ge support.
Figure 5. (a) UV-Vis-NIR diffuse reflectance spectra of the Ge and Graphene/Ge, accompanied by the corresponding Kubelka–Munk transformed reflectance spectra (b). (c) Photoluminescence (PL) spectra obtained from the surfaces of Ge and Graphene/Ge.
**Figure 6.** (a-b) Energy band diagrams of graphene and Ge before (a) and after (b) contact. (c-d) Energy band diagrams of graphene and VO$_2$ before (c) and after (d) contact. (e) The crystallographic structure of VO$_2$ (M1) and VO$_2$ (R). Upon semiconductor-to-metal transition (SMT), the linear equidistant V-V chains along c-axis (2.853 Å) in tetragonal R phase will become distorted with alternative spacings of 3.125 Å and 2.654 Å in monoclinic M phase.
Graphical abstract
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